HARRIS SEMICONDUCTOR

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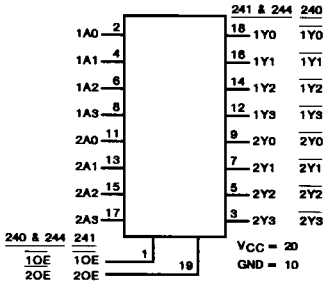
FCT Interface Logic

CD54/74FCT240, CD54/74FCT240AT
CD54/74FCT241, CD54/74FCT241AT
CD54/74FCT244, CD54/74FCT244AT

July 1990



FUNCTIONAL DIAGRAM

Octal Buffers/Line Drivers, 3-State

CD54/74FCT240, CD54/74FCT240AT - Inverting
CD54/74FCT241, CD54/74FCT241AT - Non-Inverting
CD54/74FCT244, CD54/74FCT244AT - Non-Inverting

Type Features:

- *Buffered inputs*
- *Typical propagation delay:*
  4.1ns @ V_{CC} = 5V, T_A = +25°C, C_L = 50pF (FCT240AT, FCT244AT)

The CD54/74FCT240, 240AT, 241, 241AT, 244 and 244AT 3-state octal buffers/line drivers use a small-geometry BiCMOS technology. The output stage is a combination of bipolar and CMOS transistors that limits the output-HIGH level to two diode drops below V_{CC}. This resultant lowering of output swing (0V to 3.7V) reduces power bus ringing (a source of EMI) and minimizes V_{CC} bounce and ground bounce and their effects during simultaneous output switching. The output configuration also enhances switching speed and is capable of sinking 48 to 64 milliamperes.

The CD54/74FCT240, 240AT, 244 and 244AT have active-LOW output enables ($\overline{1OE}$, $\overline{2OE}$). The CD54/74FCT241 and CD54/74FCT241AT have one active-LOW ($\overline{1OE}$) and one active-HIGH (2OE) output enable.

The CD54/74FCT240, 240AT, 241, 241AT, 244 and 244AT are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over two temperature ranges: Commercial (0°C to +70°C) and Extended Industrial (-55°C to +125°C).

Family Features:

- *SCR-latchup-resistant BiCMOS process and circuit design*
- *FCTXXX Types - Speed of bipolar FAST*/AS/S; FCTXXXAT Types - 30% faster than FAST/AS/S with significantly reduced power consumption*
- *64/48-mA output sink current (commercial/extended industrial)*
- *Output voltage swing limited to 3.7V @ V_{CC} = 5V*
- *Controlled output-edge rates*
- *Input/output isolation to V_{CC}*
- *BiCMOS technology with low quiescent power*

* FAST is a registered trademark of Fairchild Semiconductor Corp.

The CD54FCT240, 241 and 244 are also available in chip form (H suffix). These unpackaged devices are operable over the -55°C to +125°C temperature range.

4 TECHNICAL DATA

TRUTH TABLES

INPUTS		OUTPUT
$\overline{1OE}$, $\overline{2OE}$	A	$\overline{Y}$
L	L	H
L	H	L
H	X	Z

(FCT240, FCT240AT)

INPUTS		OUTPUT	INPUTS		OUTPUT
$\overline{1OE}$	1A	1Y	2OE	2A	2Y
L	L	L	L	X	Z
L	H	H	H	L	L
H	X	Z	H	H	H

(FCT241, FCT241AT)

INPUTS		OUTPUT
$\overline{1OE}$, $\overline{2OE}$	A	Y
L	L	L
L	H	H
H	X	Z

(FCT244, FCT244AT)

H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial
Z = HIGH Impedance

File Number **2227**

MAXIMUM RATINGS, *Absolute-Maximum Values:*

DC SUPPLY-VOLTAGE (V_{CC}) ..... -0.5V to 6V
DC INPUT DIODE CURRENT, I_{IK} (for V_I < -0.5V) ..... -20mA
DC OUTPUT DIODE CURRENT, I_{OK} (for V_O < -0.5V) ..... -50mA
DC OUTPUT SINK CURRENT per Output Pin, I_O ..... +70mA
DC OUTPUT SOURCE CURRENT per Output Pin, I_O ..... -30mA
DC V_{CC} CURRENT (I_{CC}) 140mA
DC GROUND CURRENT (I_{GND}) 528mA
POWER DISSIPATION PER PACKAGE (P_D):
For T_A = -55°C to +100°C (PACKAGE TYPE E) 500mW
For T_A = +100°C to +125°C (PACKAGE TYPE E) ..... Derate Linearly at 8mW/°C to 300mW
For T_A = -55°C to +70°C (PACKAGE TYPE M) 400mW
For T_A = +70°C to +125°C (PACKAGE TYPE M) ..... Derate Linearly at 6mW/°C to 70mW
OPERATING-TEMPERATURE RANGE (T_A):
PACKAGE TYPE E, M ..... -55°C to +125°C
STORAGE TEMPERATURE (T_{stg}) ..... -65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/16 in. ± 1/32 in. (1.59mm ± 0.79mm) from case for 10s maximum ..... +265°C
Unit inserted into PC board min. thickness 1/16 in. (1.59mm) with solder contacting lead tips only ..... +300°C

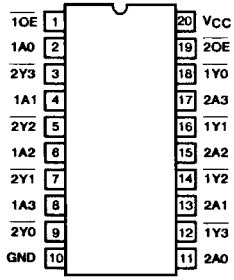
RECOMMENDED OPERATING CONDITIONS:

The following are normal operating ranges for these devices. For maximum reliability, devices should always be operated within these ranges.

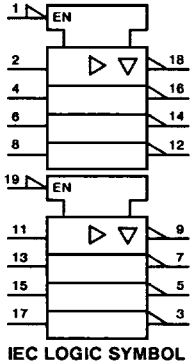
CHARACTERISTIC		LIMITS MIN	LIMITS MAX	UNITS
Supply-Voltage Range, V_{CC}*:	CD74 Series, T_A = 0°C to 70°C	4.75	5.25	V
	CD54 Series, T_A = -55°C to +125°C	4.5	5.5	V
DC Input Voltage, V_I		0	V_{CC}	V
DC Output Voltage, V_O		0	$\leq V_{CC}$	V
Operating Temperature, T_A		-55	+125	°C
Input Rise and Fall Slew Rate, dt/dv		0	10	ns/V

* Unless otherwise specified, all voltages are referenced to ground.

CD54/74FCT240/240AT TYPES

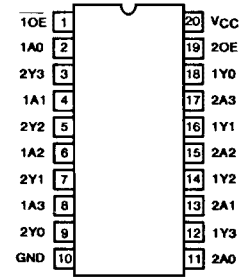


TERMINAL ASSIGNMENT



IEC LOGIC SYMBOL

CD54/74FCT241/241AT TYPES



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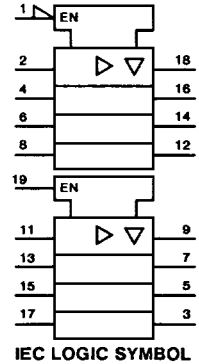
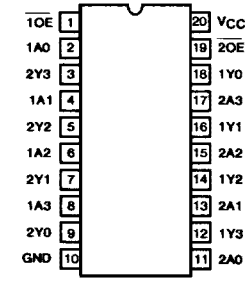


IEC LOGIC SYMBOL

CD54/74FCT244/244AT TYPES



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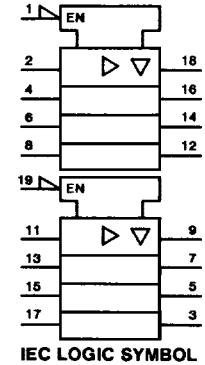


IEC LOGIC SYMBOL

STATIC ELECTRICAL CHARACTERISTICS

FCT Series: 74FCT Commercial Temperature Range, 0°C to +70°C; V_{CC} max = 5.25V, V_{CC} min = 4.75V
54FCT Extended Industrial Temperature Range, -55°C to +125°C; V_{CC} max = 5.5V, V_{CC} min = 4.5V

CHARACTERISTICS		TEST CONDITIONS			AMBIENT TEMPERATURE (T_A)						UNITS
					+25°C		0°C to +70°C		-55°C to +125°C		
		V_I (V)	I_O (mA)	V_{CC} (V)	MIN	MAX	MIN	MAX	MIN	MAX	
High-Level Input Voltage	V_{IH}			4.5 to 5.5	2	-	2	-	2	-	V
Low-Level Input Voltage	V_{IL}			4.5 to 5.5	-	0.8	-	0.8	-	0.8	V
High-Level Output Voltage	V_{OH}	V_{IH} or	-15	MIN	2.4	-	2.4	-	-	-	V
		V_{IL}	-12	MIN	2.4	-	-	-	2.4	-	V
Low-Level Output Voltage	V_{OL}	V_{IH} or	64	MIN	-	0.55	-	0.55	-	-	V
		V_{IL}	48	MIN	-	0.55	-	-	-	0.55	V
High-Level Input Current	I_{IH}	V_{CC}		MAX	-	0.1	-	1	-	1	µA
Low-Level Input Current	I_{IL}	GND		MAX	-	-0.1	-	-1	-	-1	µA
3-State Leakage Current	I_{OZH}	V_{CC}		MAX	-	0.5	-	10	-	10	µA
	I_{OZL}	GND		MAX	-	-0.5	-	-10	-	-10	µA
Short-Circuit Output Current *	I_{OS}	V_{CC} or GND $V_O = 0$		MAX	-60	-	-60	-	-60	-	mA
Input Clamp Voltage	V_{IK}	V_{CC} or GND	-18	MIN	-	-1.2	-	-1.2	-	-1.2	V
Quiescent Supply Current, MSI	I_{CC}	V_{CC} or GND	0	MAX	-	8	-	80	-	500	µA
Additional Quiescent Supply Current per Input Pin TTL Inputs High, 1 Unit Load	ΔI_{CC}	3.4V†		MAX	-	1.6	-	1.6	-	2	mA

* Not more than one output should be shorted at one time. Test duration should not exceed 100ms.

† Inputs that are not measured are at V_{CC} or GND.

FCT Input Loading: All inputs are 1 unit load. Unit load is ΔI_{CC} limit specified in Static Characteristics Chart, e.g., 1.6mA max. @ +70°C.

SWITCHING CHARACTERISTICS

FCT Series: t_r, t_f = 2.5ns, C_L = 50pF, R_L – See Figure 2

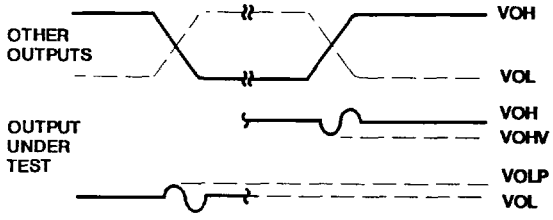
CHARACTERISTICS		SYMBOL	V_{CC} (V)	CD54/74FCT240, 241, 244					CD54/74FCT240AT, 241AT*, 244AT					UNITS
				AMBIENT TEMPERATURE (T_A)										
				+25°C	0°C to +70°C		-55°C to +125°C		+25°C	0°C to +70°C		-55°C to +125°C		
				TYP	MIN	MAX	MIN	MAX	TYP	MIN	MAX	MIN	MAX	
Propagation Delays: Data to Outputs	FCT240/AT	t_{PLH}, t_{PHL}	5†	5	1.5	8	1.5	9	4.4	1.5	5.6	1.5	6.7	ns
	FCT241/AT	t_{PLH}, t_{PHL}	5	4	1.5	6.5	1.5	7						ns
	FCT244/AT	t_{PLH}, t_{PHL}	5	4.5	1.5	6.5	1.5	7	3.8	1.5	5.3	1.5	6.2	ns
Output Enable Times	FCT240/AT	t_{PZL}, t_{PZH}	5	7	1.5	10	1.5	10.5	4.7	1.5	6.2	1.5	7.7	ns
	FCT241/AT	t_{PZL}, t_{PZH}	5	5.5	1.5	8	1.5	8.5						ns
	FCT244/AT	t_{PZL}, t_{PZH}	5	6	1.5	8	1.5	8.5	4.8	1.5	6.5	1.5	7.8	ns
Output Disable Times	FCT240/AT	t_{PLZ}, t_{PHZ}	5	6	1.5	9.5	1.5	10	4	1.5	5.6	1.5	6.5	ns
	FCT241/AT	t_{PLZ}, t_{PHZ}	5	4.5	1.5	7	1.5	7.5						ns
	FCT244/AT	t_{PLZ}, t_{PHZ}	5	5	1.5	7	1.5	7.5	4.5	1.5	5.8	1.5	6.8	ns
Power Dissipation Capacitance	FCT240/AT,	C_{PD}§		38 Typical					38 Typical					pF
	FCT241/AT,	C_{PD}§		33 Typical					33 Typical					pF
	FCT244/AT	C_{PD}§		35 Typical					35 Typical					pF
Min. (Valley) V_{OHV} During Switching of Other Outputs (Output Under Test Not Switching)		V_{OHV} See Figure 1	5	0.5 Typical @ +25°C										V
Max. (Peak) V_{OLP} During Switching of Other Outputs (Output Under Test Not Switching)		V_{OLP} See Figure 1	5	1 Typical @ +25°C										V
Input Capacitance		C_I	-	-	-	10	-	10	-	-	10	-	10	pF
3-State Output Capacitance		C_O	-	-	-	15	-	15	-	-	15	-	15	pF

†5V: min. is @ 5.5V
max. is @ 4.5V
5V: min. is @ 5.25V for 0°C to +70°C
max. is @ 4.75V for 0°C to +70°C
typ. is @ 5V

* Contact local Sales Office for availability

§C_{PD}, measured per function, is used to determine the dynamic power consumption.
P_D (per package) = V_{CC} I_{CC} + Σ (V_{CC}^2 f_i C_{PD} + V_O^2 f_o C_L + V_{CC} ΔI_{CC}D) where:
V_{CC} = supply voltage
ΔI_{CC} = flow through current x unit load
C_L = output load capacitance
D = duty cycle of input high
f_o = output frequency
f_i = input frequency

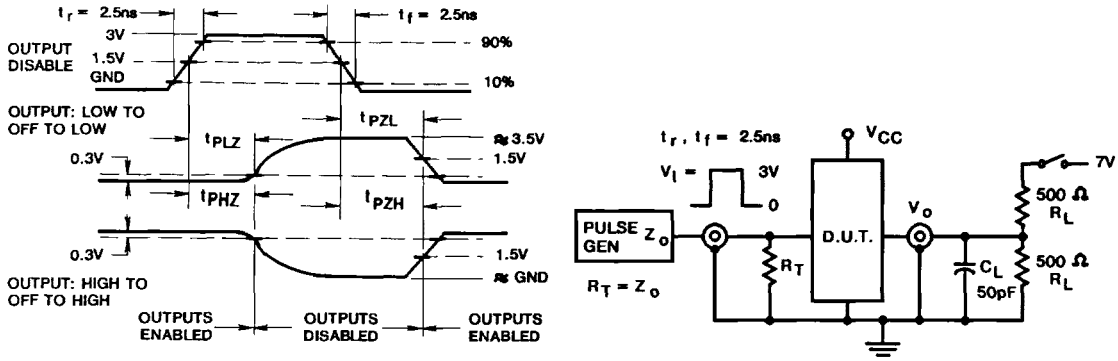
PARAMETER MEASUREMENT INFORMATION



NOTES:

1. V_{OLP} is measured with respect to a ground reference near the output under test. V_{OHV} is measured with respect to V_{OH}.
2. Input pulses have the following characteristics: PRR $\leq$ 1MHz, t_r = 2.5ns, t_f = 2.5ns, skew 1ns.
3. R.F. fixture with 700-MHz design rules required. IC should be soldered into test board and bypassed with 0.1µF capacitor. Scope and probes require 700-MHz bandwidth.

Figure 1 - Simultaneous switching transient waveforms.



TEST	SWITCH POSITION
t_{PLZ}, t_{PZL}, OPEN DRAIN	CLOSED
t_{PHZ}, t_{PZH}, t_{PLH}, t_{PHL}	OPEN

Figure 2 - Three-state propagation delay times and test circuit.

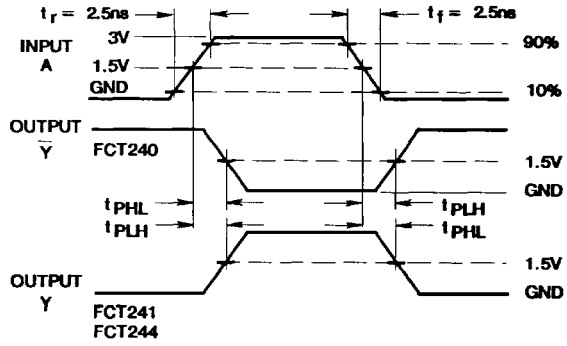


Figure 3 - Propagation delay times.